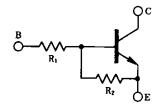


# COMPOUND TRANSISTOR HD1 SERIES

# on-chip resistor NPN silicon epitaxial transistor For mid-speed switching

#### **FEATURES**

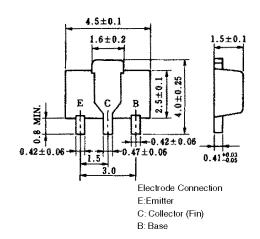
- · High current drives such as IC outputs and actuators available
- · On-chip bias resistor
- Low power consumption during drive



#### **HD1 SERIES LISTS**

Products	Marking	R <sub>1</sub> (KΩ)	R <sub>2</sub> (KΩ)
HD1A3M	LP	1.0	1.0
HD1F3P	LQ	2.2	10
HD1L3N	LR	4.7	10
HD1A4M	LS	10	10
HD1L2Q	LT	0.47	4.7
HD1F2Q	LU	0.22	2.2
HD1A4A	LX	-	10

#### PACKAGE DRAWING (UNIT: mm)



#### ABSOLUTE MAXIMUM RATINGS (Ta = 25°C)

Parameter	Symbol	Ratings	Unit
Collector to base voltage	VcBo	80	V
Collector to emitter voltage	VCEO	60	V
Emitter to base voltage	VEBO	10	V
Collector current (DC)	Ic(DC)	1.0	Α
Collector current (Pulse)	C(pulse) *	2.0	Α
Base current (DC)	I <sub>B(DC)</sub>	0.02	Α
Total power dissipation	P <sub>T</sub> **	2.0	W
Junction temperature	Tj	150	°C
Storage temperature	T <sub>stg</sub>	-55 to +150	°C

<sup>\*</sup> PW  $\leq$  10 ms, duty cycle  $\leq$  50 %

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Not all devices/types available in every country. Please check with local NEC representative for availability and additional information.

<sup>\*\*</sup> When 0.7 mm × 16 cm<sup>2</sup> ceramic board is used



#### HD1A3M ELECTRICAL CHARACTERISTICS (Ta = 25°C)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Collector cutoff current	Ісво	V <sub>CB</sub> = 60 V, I <sub>E</sub> = 0			100	nA
DC current gain	h <sub>FE1</sub> **	Vce = 2.0 V, Ic = 0.1 A	80			_
DC current gain	h <sub>FE2</sub> **	Vce = 2.0 V, Ic = 0.5 A	200			_
DC current gain	h <sub>FE3</sub> **	Vce = 2.0 V, Ic = 1.0 A	200			_
Low level output voltage	<b>V</b> OL **	V <sub>IN</sub> = 5.0 V, Ic = 0.4 A			0.35	V
Low level input voltage	VIL **	$V_{CE} = 5.0 \text{ V}, \text{ Ic} = 100 \ \mu\text{A}$			0.3	V
Input resistance	R <sub>1</sub>		0.7	1.0	1.3	kΩ
E-to-B resistance	R <sub>2</sub>		0.7	1.0	1.3	kΩ

<sup>\*\*</sup> PW  $\leq$  350  $\mu$ s, duty cycle  $\leq$  2 %

#### HD1F3P ELECTRICAL CHARACTERISTICS (Ta = 25°C)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Collector cutoff current	Ісво	Vcb = 60 V, IE = 0			100	nA
DC current gain	h <sub>FE1</sub> **	Vce = 2.0 V, Ic = 0.1 A	200	630		-
DC current gain	hFE2 **	Vce = 2.0 V, Ic = 0.5 A	300	780		ı
DC current gain	hFE3 **	Vce = 2.0 V, Ic = 1.0 A	200	430		ı
Low level output voltage	Vol **	V <sub>IN</sub> = 5.0 V, Ic = 0.3 A		0.12	0.3	V
Low level input voltage	VIL **	$V_{CE} = 5.0 \text{ V}, \text{ Ic} = 100 \ \mu\text{A}$		0.5	0.3	V
Input resistance	R <sub>1</sub>		1.54	2.2	2.86	kΩ
E-to-B resistance	R <sub>2</sub>		7	10	13	kΩ

<sup>\*\*</sup> PW  $\leq$  350  $\mu$ s, duty cycle  $\leq$  2 %

## HD1L3N ELECTRICAL CHARACTERISTICS (Ta = 25°C)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Collector cutoff current	Ісво	Vcb = 60 V, IE = 0			100	nA
DC current gain	h <sub>FE1</sub> **	Vce = 2.0 V, Ic = 0.1 A	200			-
DC current gain	h <sub>FE2</sub> **	Vce = 2.0 V, Ic = 0.5 A	300			ı
DC current gain	h <sub>FE3</sub> **	Vce = 2.0 V, Ic = 1.0 A	200			ı
Low level output voltage	Vol **	V <sub>IN</sub> = 5.0 V, Ic = 0.2 A			0.2	٧
Low level input voltage	VIL **	$V_{CE} = 5.0 \text{ V}, \text{ Ic} = 100 \ \mu\text{A}$			0.3	V
Input resistance	R <sub>1</sub>		3.29	4.7	6.11	kΩ
E-to-B resistance	R <sub>2</sub>		7	10	13	kΩ

<sup>\*\*</sup> PW  $\leq$  350  $\mu$ s, duty cycle  $\leq$  2 %



HD1A4M ELECTRICAL CHARACTERISTICS (Ta = 25°C)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Collector cutoff current	Ісво	Vcb = 60 V, IE = 0			100	nA
DC current gain	h <sub>FE1</sub> **	Vce = 2.0 V, Ic = 0.1 A	200			-
DC current gain	hFE2 **	Vce = 2.0 V, Ic = 0.5 A	300			-
DC current gain	hFE3 **	Vce = 2.0 V, Ic = 1.0 A	200			-
Low level output voltage	Vol **	V <sub>IN</sub> = 5.0 V, Ic = 0.1 A			0.2	V
Low level input voltage	VIL **	$V_{CE} = 5.0 \text{ V}, \text{ Ic} = 100 \ \mu\text{A}$			0.3	V
Input resistance	R <sub>1</sub>		7	10	13	kΩ
E-to-B resistance	R <sub>2</sub>		7	10	13	kΩ

<sup>\*\*</sup> PW  $\leq$  350  $\mu$ s, duty cycle  $\leq$  2 %

### HD1L2Q ELECTRICAL CHARACTERISTICS (Ta = 25°C)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Collector cutoff current	Ісво	V <sub>CB</sub> = 60 V, I <sub>E</sub> = 0			100	nA
DC current gain	h <sub>FE1</sub> **	Vce = 2.0 V, Ic = 0.1 A	200			-
DC current gain	hFE2 **	Vce = 2.0 V, Ic = 0.5 A	300			_
DC current gain	h <sub>FE3</sub> **	Vce = 2.0 V, Ic = 1.0 A	200			_
Low level output voltage	<b>V</b> ol **	V <sub>IN</sub> = 5.0 V, Ic = 0.8 A			0.5	V
Low level input voltage	VIL **	$V_{CE} = 5.0 \text{ V}, \text{ Ic} = 100 \ \mu\text{A}$			0.3	V
Input resistance	R <sub>1</sub>		329	470	611	Ω
E-to-B resistance	R <sub>2</sub>		3.29	4.7	6.11	kΩ

<sup>\*\*</sup> PW  $\leq$  350  $\mu$ s, duty cycle  $\leq$  2 %

# HD1F2Q ELECTRICAL CHARACTERISTICS (Ta = 25°C)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Collector cutoff current	Ісво	Vcb = 60 V, IE = 0			100	nA
DC current gain	h <sub>FE1</sub> **	VcE = 2.0 V, Ic = 0.1 A	100			_
DC current gain	hFE2 **	Vce = 2.0 V, Ic = 0.5 A	300			-
DC current gain	h <sub>FE3</sub> **	Vce = 2.0 V, lc = 1.0 A	200			_
Low level output voltage	<b>V</b> ol **	V <sub>IN</sub> = 5.0 V, Ic = 0.8 A			0.5	V
Low level input voltage	VIL **	$V_{CE} = 5.0 \text{ V}, \text{ Ic} = 100 \ \mu\text{A}$			0.3	V
Input resistance	R <sub>1</sub>		154	220	286	Ω
E-to-B resistance	R <sub>2</sub>		1.54	2.2	2.86	kΩ

<sup>\*\*</sup> PW  $\leq$  350  $\mu$ s, duty cycle  $\leq$  2 %

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HD1A4A ELECTRICAL CHARACTERISTICS (Ta = 25°C)

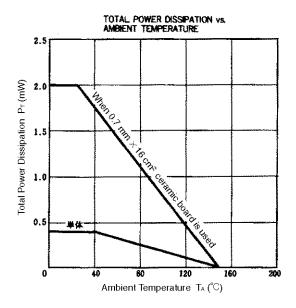
Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Collector cutoff current	Ісво	V <sub>CB</sub> = 60 V, I <sub>E</sub> = 0			100	nA
DC current gain	h <sub>FE1</sub> **	Vce = 2.0 V, Ic = 0.1 A	200	630		-
DC current gain	hFE2 **	Vce = 2.0 V, Ic = 0.5 A	300	780		-
DC current gain	h <sub>FE3</sub> **	Vce = 2.0 V, Ic = 1.0 A	200	430		-
Collector saturation voltage	V <sub>CE(sat)</sub> **	Ic = 0.7 A, I <sub>B</sub> = 7 mA		0.25	0.4	V
Low level input voltage	VIL **	$V_{CE} = 5.0 \text{ V}, \text{ Ic} = 100 \ \mu\text{A}$		0.5	0.3	V
Input resistance	R <sub>1</sub>		-	-	-	Ω
E-to-B resistance	R <sub>2</sub>		7	10	13	kΩ

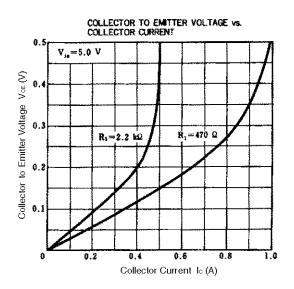
<sup>\*\*</sup> PW  $\leq$  350  $\mu$ s, duty cycle  $\leq$  2 %

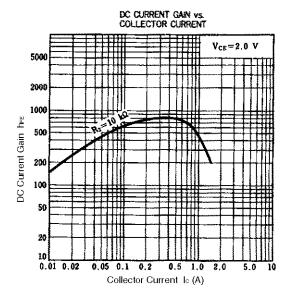
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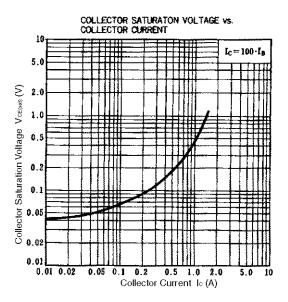


#### TYPICAL CHARACTERISTICS (Ta = 25°C)









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